



Layer	Name	Material	Thickness	Constant	Gerber	Board Layer Stack
	Top Overlay				GTO	
	Top Solder	SM-001	0.025mm	4	GTS	
	Top Surface Finish	PbSn	0.020mm			
1	Top Layer	CF-004	0.035mm		GTL	
	Dielectric 1	Core-043	1.499mm	4.3		
2	Bottom Layer	CF-004	0.035mm		GBL	
	Bottom Surface Finish	PbSn	0.020mm			
	Bottom Solder	SM-001	0.025mm	4	GBS	
	Bottom Overlay				GBO	

Total board thickness: 1.659mm

Client Name: Blues Wireless
Project Name: Mojo 1.1

File: Mojo.PcbDoc
Rev: v4

- NOTES:**
UNLESS OTHERWISE SPECIFIED:
- 1. Board Dimension: 25.40mm x 25.40mm
 - 2. Total Thickness: 1.6 mm +/- 10%
 - 3. Board Material: FR-4, Tg130+
 - 4. Copper Layers: 2, Weight: 1 oz
 - 5. Soldermask Layers: Both, Color: Black (LPI preferred)
 - 6. Legend Layers: Both, Color: White. (LPI preferred)
 - 7. Finish: HASL
 - 8. Fabricate PCB According to IPC-6012 Class 1
 - 9. 1.5 mm (0.06") maximum radius on any inside corner.

- SPECIAL REQUIREMENTS:**
- 10. A SMD test pad on bottom is normally tented (1 place)

- VENDOR NOTES:**
- 11. Route board shape and any cut outs per Board Outline layer.
 - 12. Place added marking (Job Number, Date Code, Mfg ID, etc) on bottom
 - 13. Boards must pass visual inspection per IPC-A-600 Class 1

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